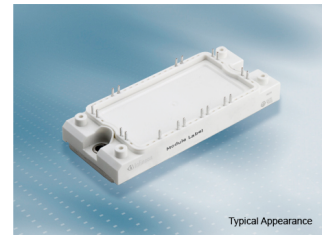


## EconoPACK™2 module with TRENCHSTOP™ IGBT7 and emitter controlled 7 diode and NTC

### Features

- Electrical features
  - $V_{CES} = 1200\text{ V}$
  - $I_{C\text{ nom}} = 75\text{ A} / I_{CRM} = 150\text{ A}$
  - TRENCHSTOP™ IGBT7
  - Low  $V_{CE,\text{sat}}$
  - Overload operation up to  $175^\circ\text{C}$
- Mechanical features
  - High power and thermal cycling capability
  - Integrated NTC temperature sensor
  - Copper base plate
  - $\text{Al}_2\text{O}_3$  substrate with low thermal resistance
  - Solder contact technology
  - Standard housing



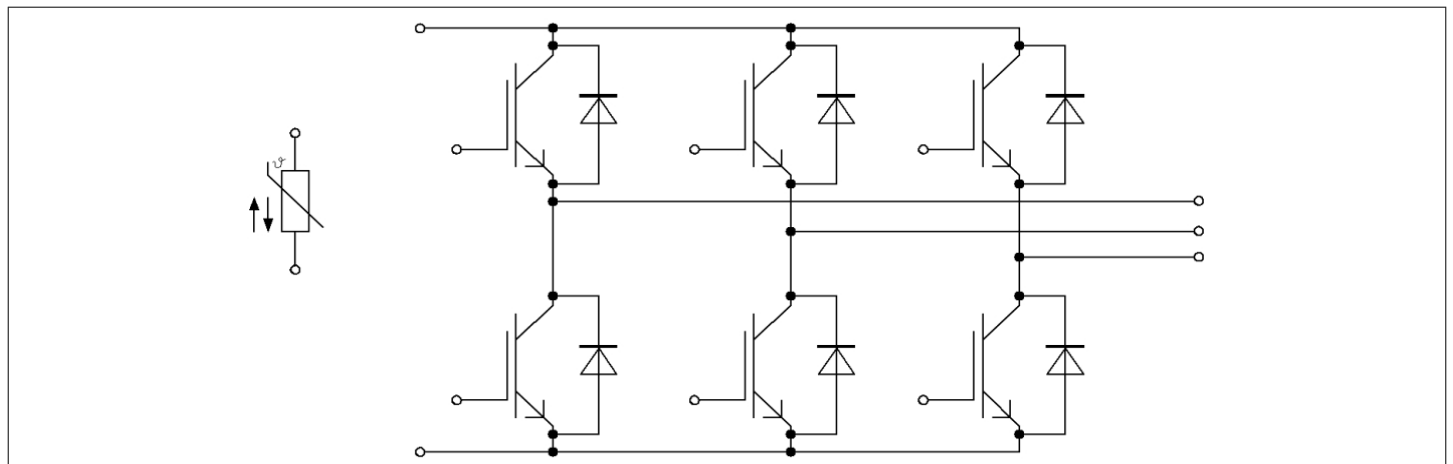
### Potential applications

- Auxiliary inverters
- Motor drives
- Servo drives

### Product validation

- Qualified for industrial applications according to the relevant tests of IEC 60747, 60749 and 60068

### Description



## Table of contents

	<b>Description</b> .....	1
	<b>Features</b> .....	1
	<b>Potential applications</b> .....	1
	<b>Product validation</b> .....	1
	<b>Table of contents</b> .....	2
<b>1</b>	<b>Package</b> .....	3
<b>2</b>	<b>IGBT, Inverter</b> .....	3
<b>3</b>	<b>Diode, Inverter</b> .....	5
<b>4</b>	<b>NTC-Thermistor</b> .....	6
<b>5</b>	<b>Characteristics diagrams</b> .....	7
<b>6</b>	<b>Circuit diagram</b> .....	12
<b>7</b>	<b>Package outlines</b> .....	13
<b>8</b>	<b>Module label code</b> .....	14
	<b>Revision history</b> .....	15
	<b>Disclaimer</b> .....	16

## 1 Package

**Table 1** Insulation coordination

Parameter	Symbol	Note or test condition	Values	Unit
Isolation test voltage	$V_{ISOL}$	RMS, $f = 50 \text{ Hz}$ , $t = 1 \text{ min}$	2.5	kV
Material of module baseplate			Cu	
Internal isolation		basic insulation (class 1, IEC 61140)	$\text{Al}_2\text{O}_3$	
Creepage distance	$d_{Creep}$	terminal to heatsink	10.0	mm
Clearance	$d_{Clear}$	terminal to heatsink	7.5	mm
Comparative tracking index	$CTI$		>200	
Relative thermal index (electrical)	$RTI$	housing	140	°C

**Table 2** Characteristic values

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Stray inductance module	$L_{SCE}$			17		nH
Module lead resistance, terminals - chip	$R_{CC'+EE'}$	$T_C = 25^\circ\text{C}$ , per switch		3.3		mΩ
Storage temperature	$T_{stg}$		-40		125	°C
Mounting torque for module mounting	$M$	- Mounting according to valid application note	M5, Screw	3	6	Nm
Weight	$G$			180		g

Note: The current under continuous operation is limited to 50A rms per connector pin.

## 2 IGBT, Inverter

**Table 3** Maximum rated values

Parameter	Symbol	Note or test condition	Values	Unit
Collector-emitter voltage	$V_{CES}$	$T_{vj} = 25^\circ\text{C}$	1200	V
Continuous DC collector current	$I_{CDC}$	$T_{vj \text{ max}} = 175^\circ\text{C}$ $T_C = 100^\circ\text{C}$	75	A
Repetitive peak collector current	$I_{CRM}$	$t_p = 1 \text{ ms}$	150	A
Gate-emitter peak voltage	$V_{GES}$		±20	V

**Table 4** Characteristic values

Parameter	Symbol	Note or test condition	Values			Unit	
			Min.	Typ.	Max.		
Collector-emitter saturation voltage	$V_{CE\ sat}$	$I_C = 75\ A, V_{GE} = 15\ V$	$T_{vj} = 25\ ^\circ C$		1.55	1.80	V
			$T_{vj} = 125\ ^\circ C$		1.69		
			$T_{vj} = 175\ ^\circ C$		1.77		
Gate threshold voltage	$V_{GEth}$	$I_C = 1.28\ mA, V_{CE} = V_{GE}, T_{vj} = 25\ ^\circ C$		5.15	5.80	6.45	V
Gate charge	$Q_G$	$V_{GE} = \pm 15\ V, V_{CE} = 600\ V$			1.25		$\mu C$
Internal gate resistor	$R_{Gint}$	$T_{vj} = 25\ ^\circ C$			2		$\Omega$
Input capacitance	$C_{ies}$	$f = 100\ kHz, T_{vj} = 25\ ^\circ C, V_{CE} = 25\ V, V_{GE} = 0\ V$			15.1		nF
Reverse transfer capacitance	$C_{res}$	$f = 100\ kHz, T_{vj} = 25\ ^\circ C, V_{CE} = 25\ V, V_{GE} = 0\ V$			0.053		nF
Collector-emitter cut-off current	$I_{CES}$	$V_{CE} = 1200\ V, V_{GE} = 0\ V$	$T_{vj} = 25\ ^\circ C$			0.014	mA
Gate-emitter leakage current	$I_{GES}$	$V_{CE} = 0\ V, V_{GE} = 20\ V, T_{vj} = 25\ ^\circ C$				100	nA
Turn-on delay time (inductive load)	$t_{don}$	$I_C = 75\ A, V_{CE} = 600\ V, V_{GE} = \pm 15\ V, R_{Gon} = 5.6\ \Omega$	$T_{vj} = 25\ ^\circ C$		0.164		$\mu s$
			$T_{vj} = 125\ ^\circ C$		0.178		
			$T_{vj} = 175\ ^\circ C$		0.185		
Rise time (inductive load)	$t_r$	$I_C = 75\ A, V_{CE} = 600\ V, V_{GE} = \pm 15\ V, R_{Gon} = 5.6\ \Omega$	$T_{vj} = 25\ ^\circ C$		0.048		$\mu s$
			$T_{vj} = 125\ ^\circ C$		0.053		
			$T_{vj} = 175\ ^\circ C$		0.057		
Turn-off delay time (inductive load)	$t_{doff}$	$I_C = 75\ A, V_{CE} = 600\ V, V_{GE} = \pm 15\ V, R_{Goff} = 5.6\ \Omega$	$T_{vj} = 25\ ^\circ C$		0.300		$\mu s$
			$T_{vj} = 125\ ^\circ C$		0.380		
			$T_{vj} = 175\ ^\circ C$		0.420		
Fall time (inductive load)	$t_f$	$I_C = 75\ A, V_{CE} = 600\ V, V_{GE} = \pm 15\ V, R_{Goff} = 5.6\ \Omega$	$T_{vj} = 25\ ^\circ C$		0.120		$\mu s$
			$T_{vj} = 125\ ^\circ C$		0.200		
			$T_{vj} = 175\ ^\circ C$		0.270		
Turn-on energy loss per pulse	$E_{on}$	$I_C = 75\ A, V_{CE} = 600\ V, L_\sigma = 35\ nH, V_{GE} = \pm 15\ V, R_{Gon} = 5.6\ \Omega, di/dt = 1200\ A/\mu s (T_{vj} = 175\ ^\circ C)$	$T_{vj} = 25\ ^\circ C$		7.96		mJ
			$T_{vj} = 125\ ^\circ C$		10.8		
			$T_{vj} = 175\ ^\circ C$		12.3		
Turn-off energy loss per pulse	$E_{off}$	$I_C = 75\ A, V_{CE} = 600\ V, L_\sigma = 35\ nH, V_{GE} = \pm 15\ V, R_{Goff} = 5.6\ \Omega, dv/dt = 3200\ V/\mu s (T_{vj} = 175\ ^\circ C)$	$T_{vj} = 25\ ^\circ C$		5.02		mJ
			$T_{vj} = 125\ ^\circ C$		7.68		
			$T_{vj} = 175\ ^\circ C$		9.46		
SC data	$I_{SC}$	$V_{GE} \leq 15\ V, V_{CC} = 800\ V, V_{CEmax} = V_{CES} - L_{sCE} * di/dt$	$t_p \leq 8\ \mu s, T_{vj} = 150\ ^\circ C$		260		A
			$t_p \leq 7\ \mu s, T_{vj} = 175\ ^\circ C$		250		

(table continues...)

**Table 4 (continued) Characteristic values**

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Thermal resistance, junction to case	$R_{thJC}$	per IGBT			0.475	K/W
Thermal resistance, case to heat sink	$R_{thCH}$	per IGBT, $\lambda_{grease} = 1 \text{ W}/(\text{m}^2\text{K})$		0.141		K/W
Temperature under switching conditions	$T_{vj\text{op}}$		-40		175	°C

Note:  $T_{vj\text{op}} > 150^\circ\text{C}$  is allowed for operation at overload conditions. For detailed specifications, please refer to AN2018-14.

### 3 Diode, Inverter

**Table 5 Maximum rated values**

Parameter	Symbol	Note or test condition	Values	Unit	
Repetitive peak reverse voltage	$V_{RRM}$	$T_{vj} = 25^\circ\text{C}$	1200	V	
Continuous DC forward current	$I_F$		75	A	
Repetitive peak forward current	$I_{FRM}$	$t_p = 1 \text{ ms}$	150	A	
$I^2t$ - value	$I^2t$	$t_p = 10 \text{ ms}, V_R = 0 \text{ V}$	$T_{vj} = 125^\circ\text{C}$	1150	$\text{A}^2\text{s}$
			$T_{vj} = 175^\circ\text{C}$	740	

**Table 6 Characteristic values**

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Forward voltage	$V_F$	$I_F = 75 \text{ A}, V_{GE} = 0 \text{ V}$	$T_{vj} = 25^\circ\text{C}$	1.72	2.10	V
			$T_{vj} = 125^\circ\text{C}$	1.59		
			$T_{vj} = 175^\circ\text{C}$	1.52		
Peak reverse recovery current	$I_{RM}$	$V_R = 600 \text{ V}, I_F = 75 \text{ A}, V_{GE} = -15 \text{ V}, -di_F/dt = 1200 \text{ A}/\mu\text{s} (T_{vj} = 175^\circ\text{C})$	$T_{vj} = 25^\circ\text{C}$	43		A
			$T_{vj} = 125^\circ\text{C}$	56		
			$T_{vj} = 175^\circ\text{C}$	65		
Recovered charge	$Q_r$	$V_R = 600 \text{ V}, I_F = 75 \text{ A}, V_{GE} = -15 \text{ V}, -di_F/dt = 1200 \text{ A}/\mu\text{s} (T_{vj} = 175^\circ\text{C})$	$T_{vj} = 25^\circ\text{C}$	4.94		$\mu\text{C}$
			$T_{vj} = 125^\circ\text{C}$	10.2		
			$T_{vj} = 175^\circ\text{C}$	13.7		

(table continues...)

**Table 6 (continued) Characteristic values**

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Reverse recovery energy	$E_{rec}$	$V_R = 600\text{ V}$ , $I_F = 75\text{ A}$ , $V_{GE} = -15\text{ V}$ , $-di_F/dt = 1200\text{ A}/\mu\text{s}$ ( $T_{vj} = 175\text{ °C}$ )	$T_{vj} = 25\text{ °C}$	1.45		mJ
			$T_{vj} = 125\text{ °C}$	3.32		
			$T_{vj} = 175\text{ °C}$	4.62		
Thermal resistance, junction to case	$R_{thJC}$	per diode			0.708	K/W
Thermal resistance, case to heat sink	$R_{thCH}$	per diode, $\lambda_{grease} = 1\text{ W}/(\text{m}^*\text{K})$		0.153		K/W
Temperature under switching conditions	$T_{vj\text{ op}}$		-40		175	°C

Note:  $T_{vj\text{ op}} > 150\text{ °C}$  is allowed for operation at overload conditions. For detailed specifications, please refer to AN2018-14.

## 4 NTC-Thermistor

**Table 7 Characteristic values**

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Rated resistance	$R_{25}$	$T_{NTC} = 25\text{ °C}$		5		kΩ
Deviation of $R_{100}$	$\Delta R/R$	$T_{NTC} = 100\text{ °C}$ , $R_{100} = 493\text{ }\Omega$	-5		5	%
Power dissipation	$P_{25}$	$T_{NTC} = 25\text{ °C}$			20	mW
B-value	$B_{25/50}$	$R_2 = R_{25} \exp[B_{25/50}(1/T_2 - 1/(298,15\text{ K}))]$		3375		K
B-value	$B_{25/80}$	$R_2 = R_{25} \exp[B_{25/80}(1/T_2 - 1/(298,15\text{ K}))]$		3411		K
B-value	$B_{25/100}$	$R_2 = R_{25} \exp[B_{25/100}(1/T_2 - 1/(298,15\text{ K}))]$		3433		K

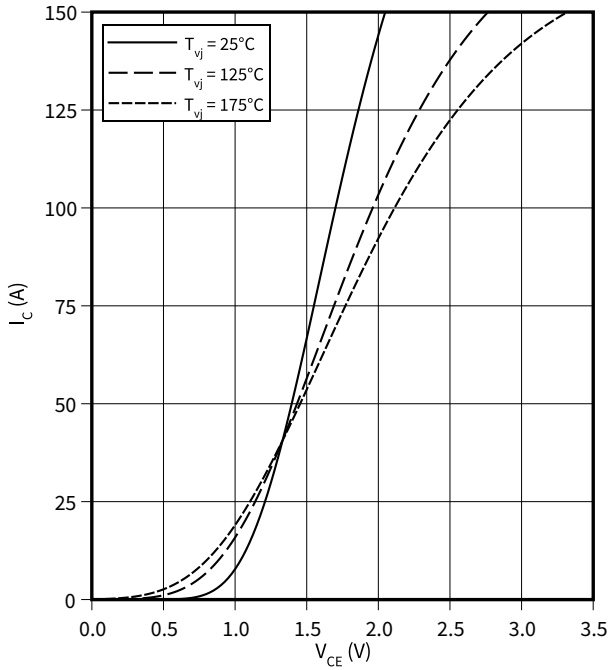
Note: Specification according to the valid application note.

## 5 Characteristics diagrams

### Output characteristic (typical), IGBT, Inverter

$$I_C = f(V_{CE})$$

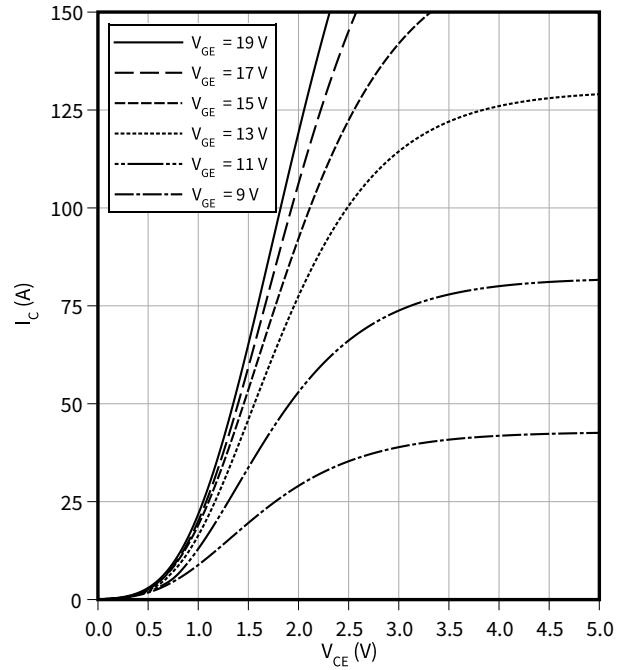
$$V_{GE} = 15 \text{ V}$$



### Output characteristic field (typical), IGBT, Inverter

$$I_C = f(V_{CE})$$

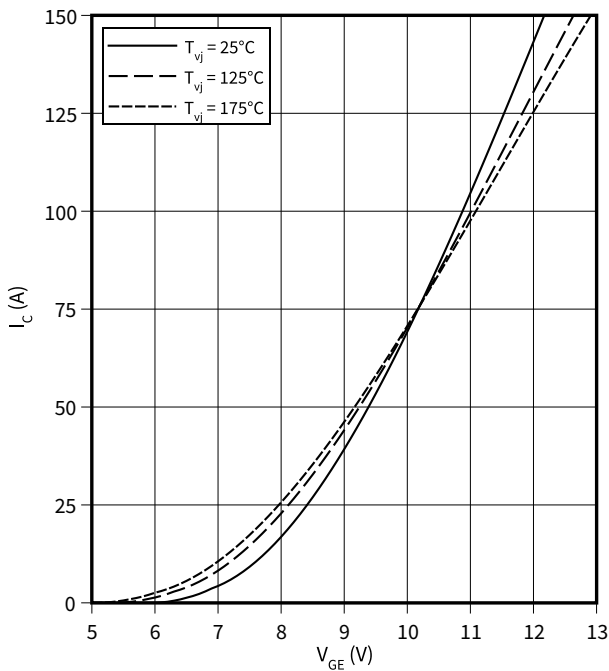
$$T_{vj} = 175 \text{ °C}$$



### Transfer characteristic (typical), IGBT, Inverter

$$I_C = f(V_{GE})$$

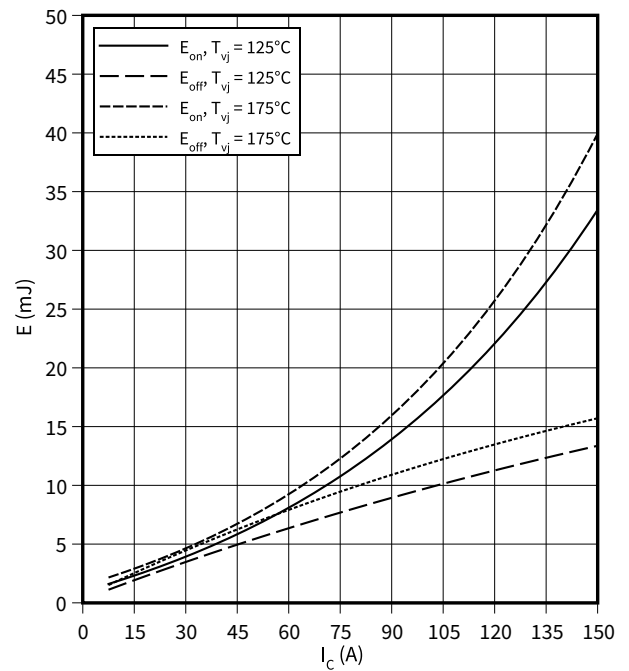
$$V_{CE} = 20 \text{ V}$$



### Switching losses (typical), IGBT, Inverter

$$E = f(I_C)$$

$$R_{Goff} = 5.6 \text{ } \Omega, R_{Gon} = 5.6 \text{ } \Omega, V_{CE} = 600 \text{ V}, V_{GE} = \pm 15 \text{ V}$$

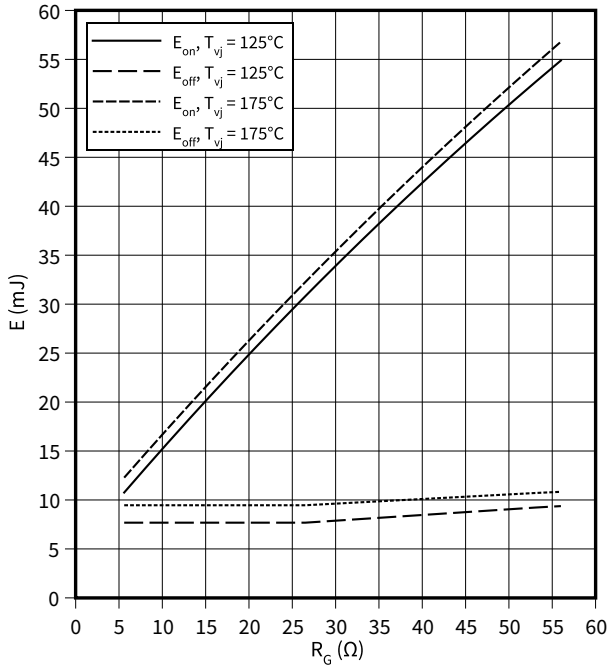


**5 Characteristics diagrams**

**Switching losses (typical), IGBT, Inverter**

$E = f(R_G)$

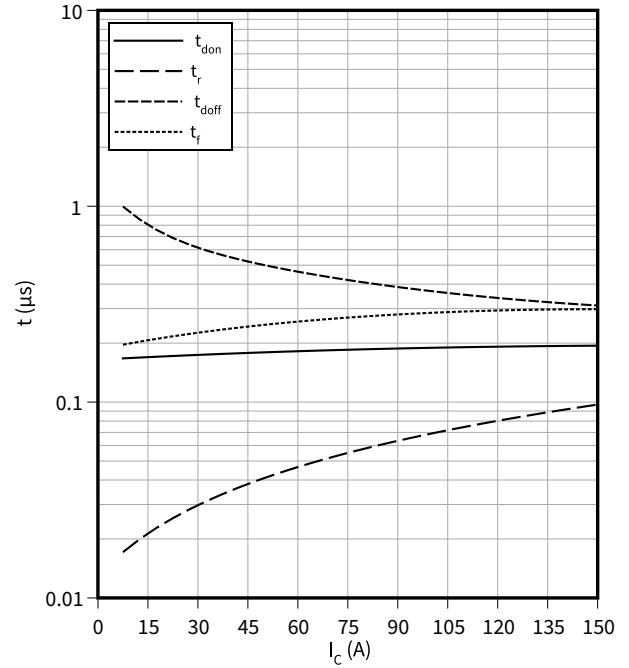
$I_C = 75 \text{ A}, V_{CE} = 600 \text{ V}, V_{GE} = \pm 15 \text{ V}$



**Switching times (typical), IGBT, Inverter**

$t = f(I_C)$

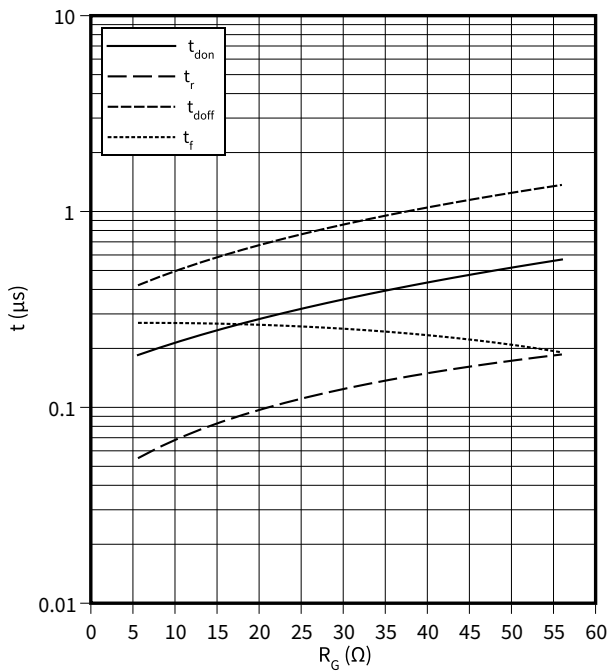
$R_{Goff} = 5.6 \Omega, R_{Gon} = 5.6 \Omega, V_{CE} = 600 \text{ V}, V_{GE} = \pm 15 \text{ V}, T_{vj} = 175 \text{ °C}$



**Switching times (typical), IGBT, Inverter**

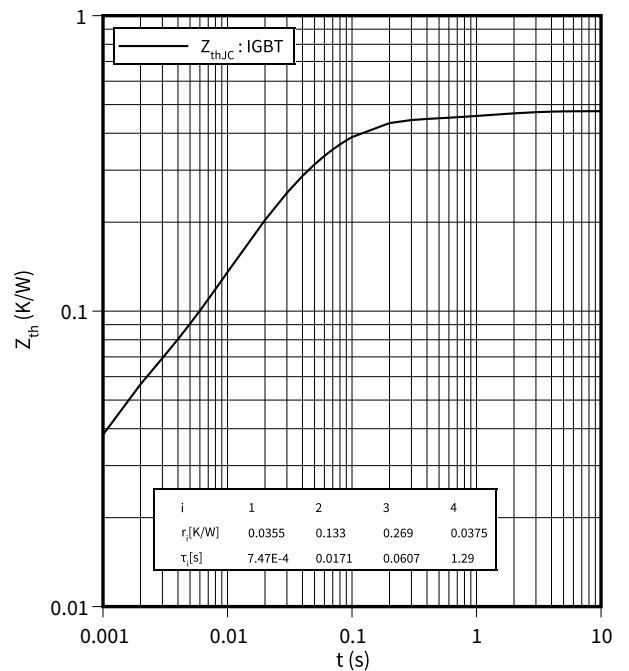
$t = f(R_G)$

$I_C = 75 \text{ A}, V_{CE} = 600 \text{ V}, V_{GE} = \pm 15 \text{ V}, T_{vj} = 175 \text{ °C}$



**Transient thermal impedance, IGBT, Inverter**

$Z_{th} = f(t)$



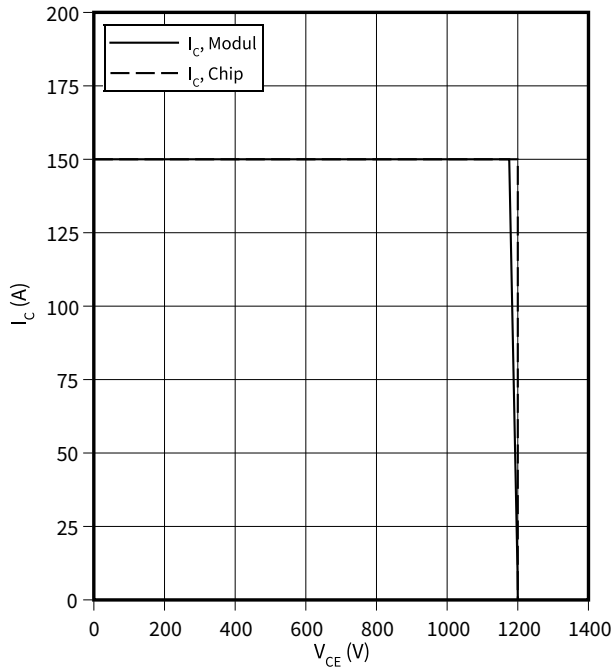


5 Characteristics diagrams

**Reverse bias safe operating area (RBSOA), IGBT, Inverter**

$I_C = f(V_{CE})$

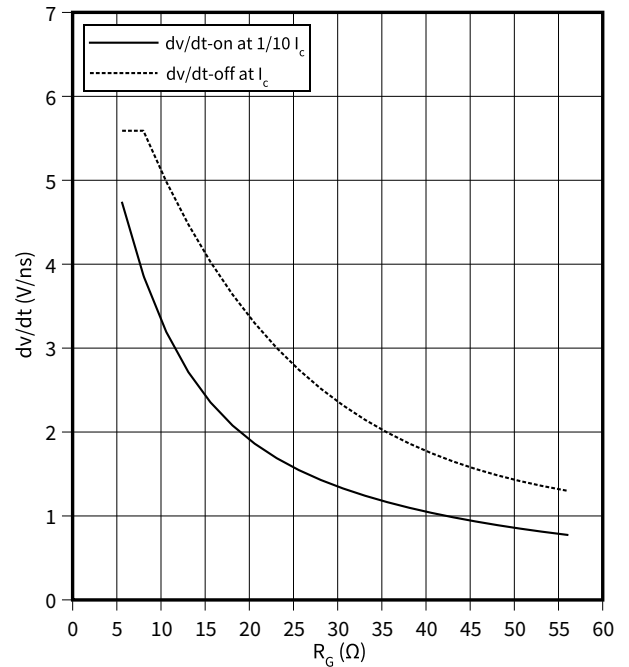
$R_{Goff} = 5.6 \Omega$ ,  $V_{GE} = \pm 15 \text{ V}$ ,  $T_{vj} = 175 \text{ }^\circ\text{C}$



**Voltage slope (typical), IGBT, Inverter**

$dv/dt = f(R_G)$

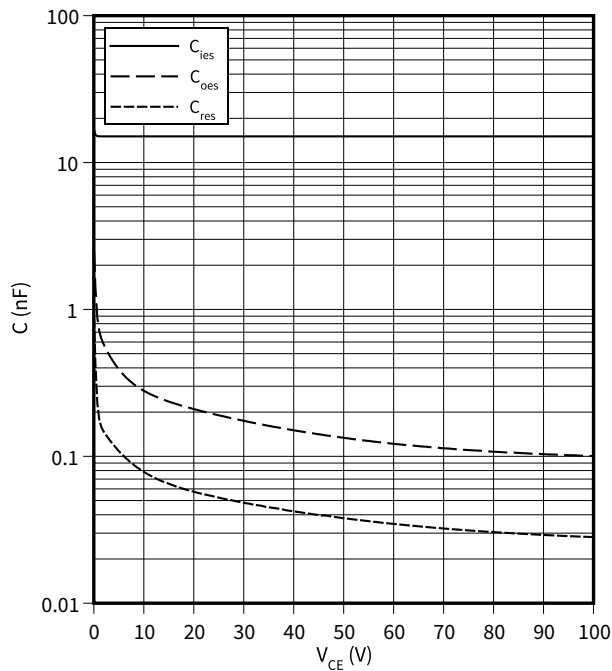
$I_C = 75 \text{ A}$ ,  $V_{CE} = 600 \text{ V}$ ,  $V_{GE} = \pm 15 \text{ V}$ ,  $T_{vj} = 25 \text{ }^\circ\text{C}$



**Capacity characteristic (typical), IGBT, Inverter**

$C = f(V_{CE})$

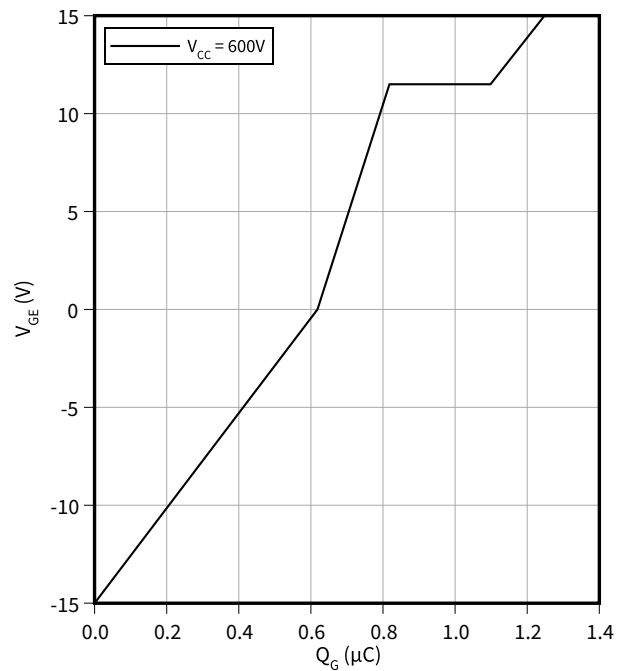
$f = 100 \text{ kHz}$ ,  $V_{GE} = 0 \text{ V}$ ,  $T_{vj} = 25 \text{ }^\circ\text{C}$



**Gate charge characteristic (typical), IGBT, Inverter**

$V_{GE} = f(Q_G)$

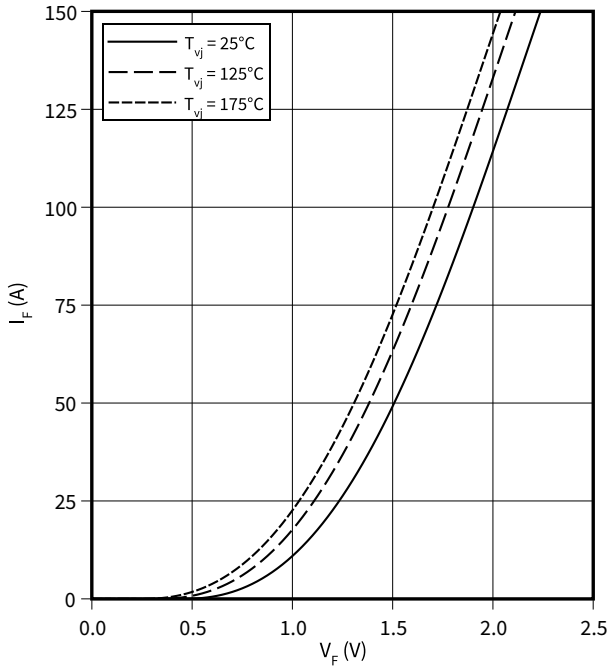
$I_C = 75 \text{ A}$ ,  $T_{vj} = 25 \text{ }^\circ\text{C}$



5 Characteristics diagrams

**Forward characteristic (typical), Diode, Inverter**

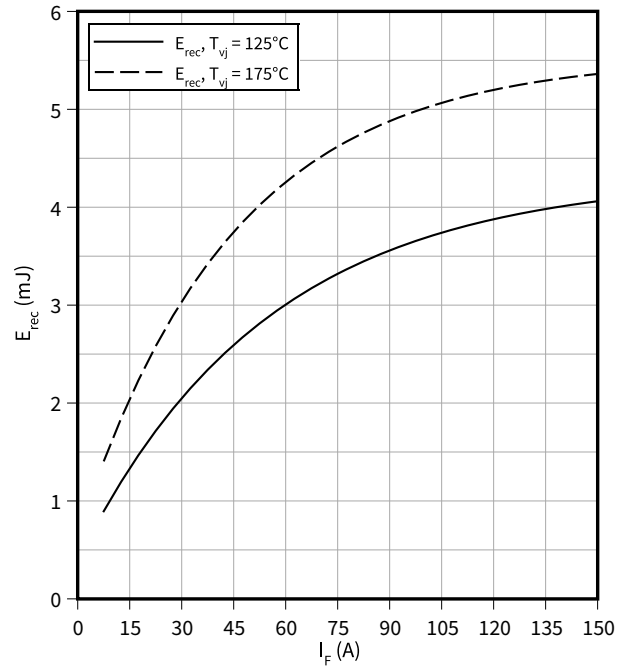
$I_F = f(V_F)$



**Switching losses (typical), Diode, Inverter**

$E_{rec} = f(I_F)$

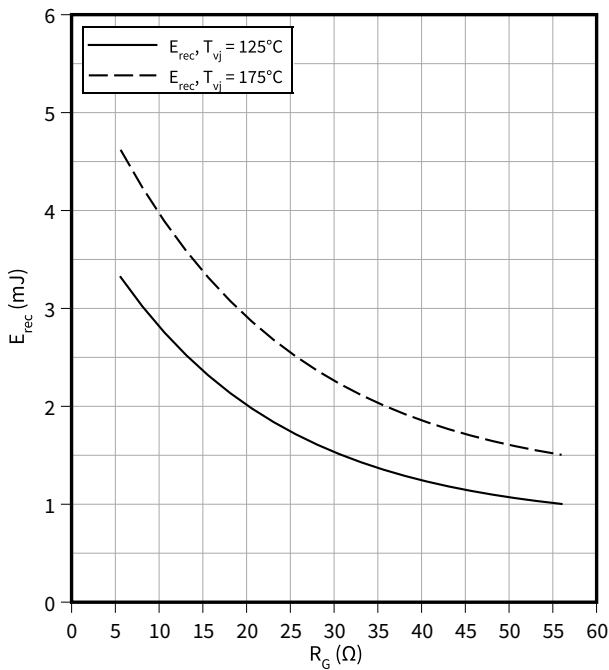
$R_{Gon} = 5.6 \Omega, V_R = 600 \text{ V}$



**Switching losses (typical), Diode, Inverter**

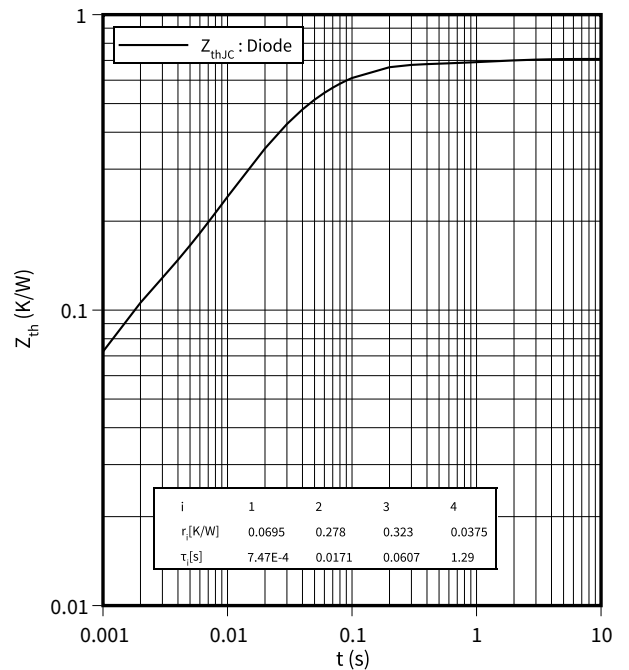
$E_{rec} = f(R_G)$

$I_F = 75 \text{ A}, V_R = 600 \text{ V}$



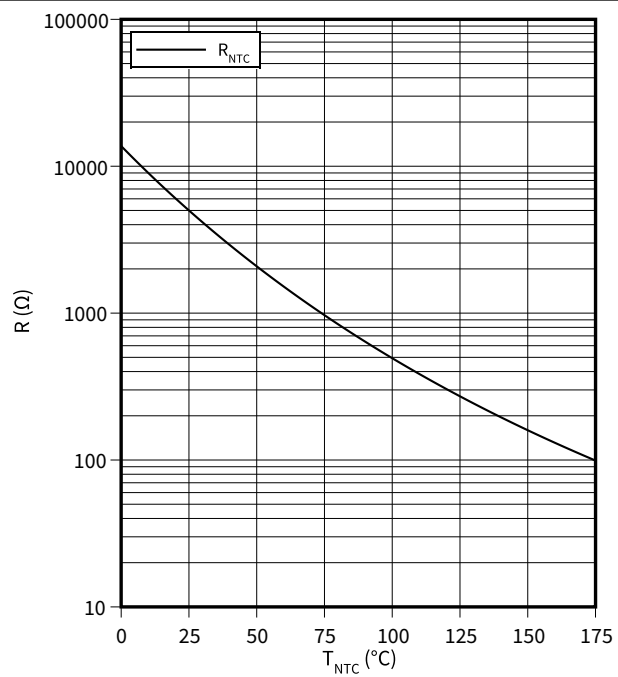
**Transient thermal impedance, Diode, Inverter**

$Z_{th} = f(t)$



Temperature characteristic (typical), NTC-Thermistor

$$R = f(T_{NTC})$$



## 6 Circuit diagram

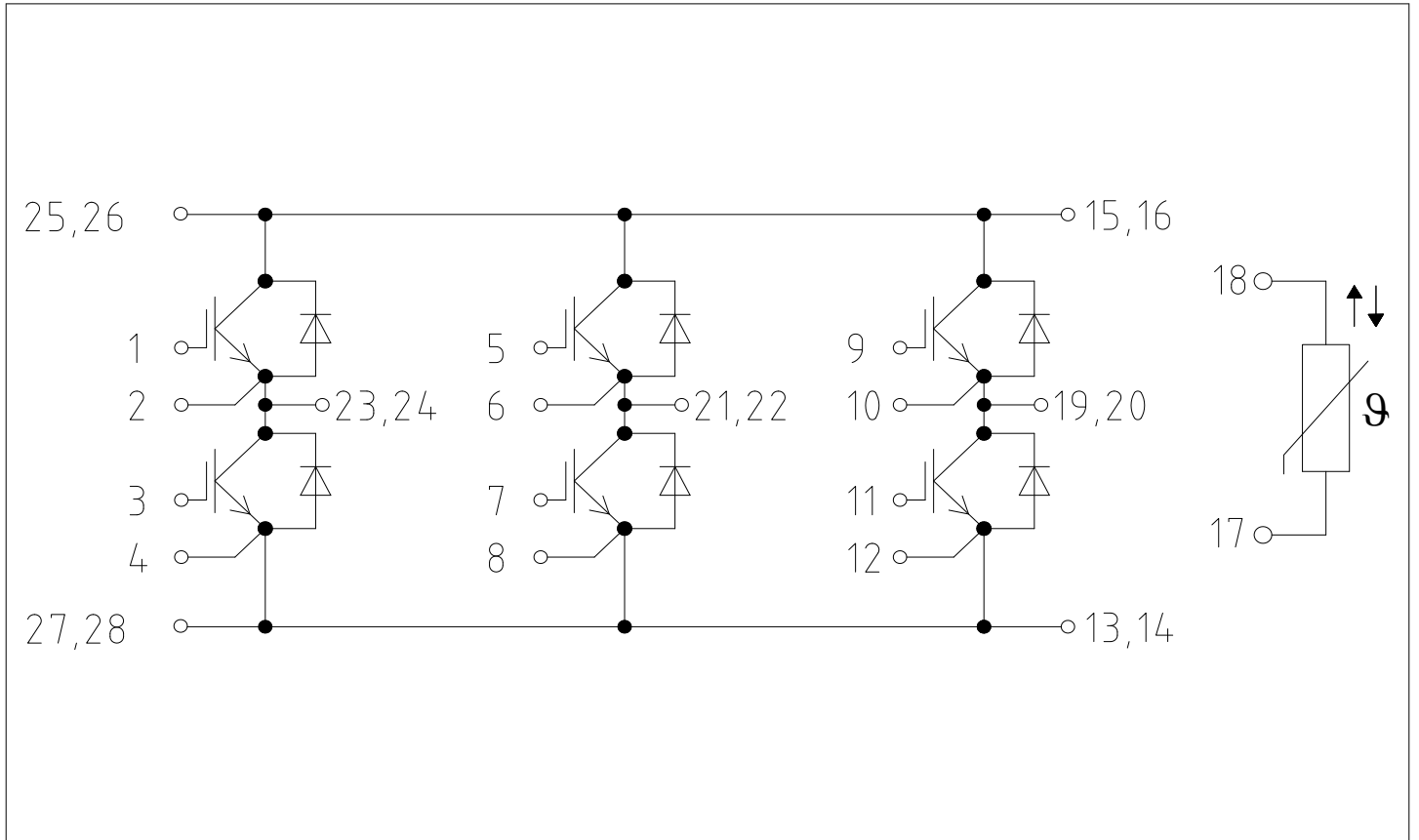
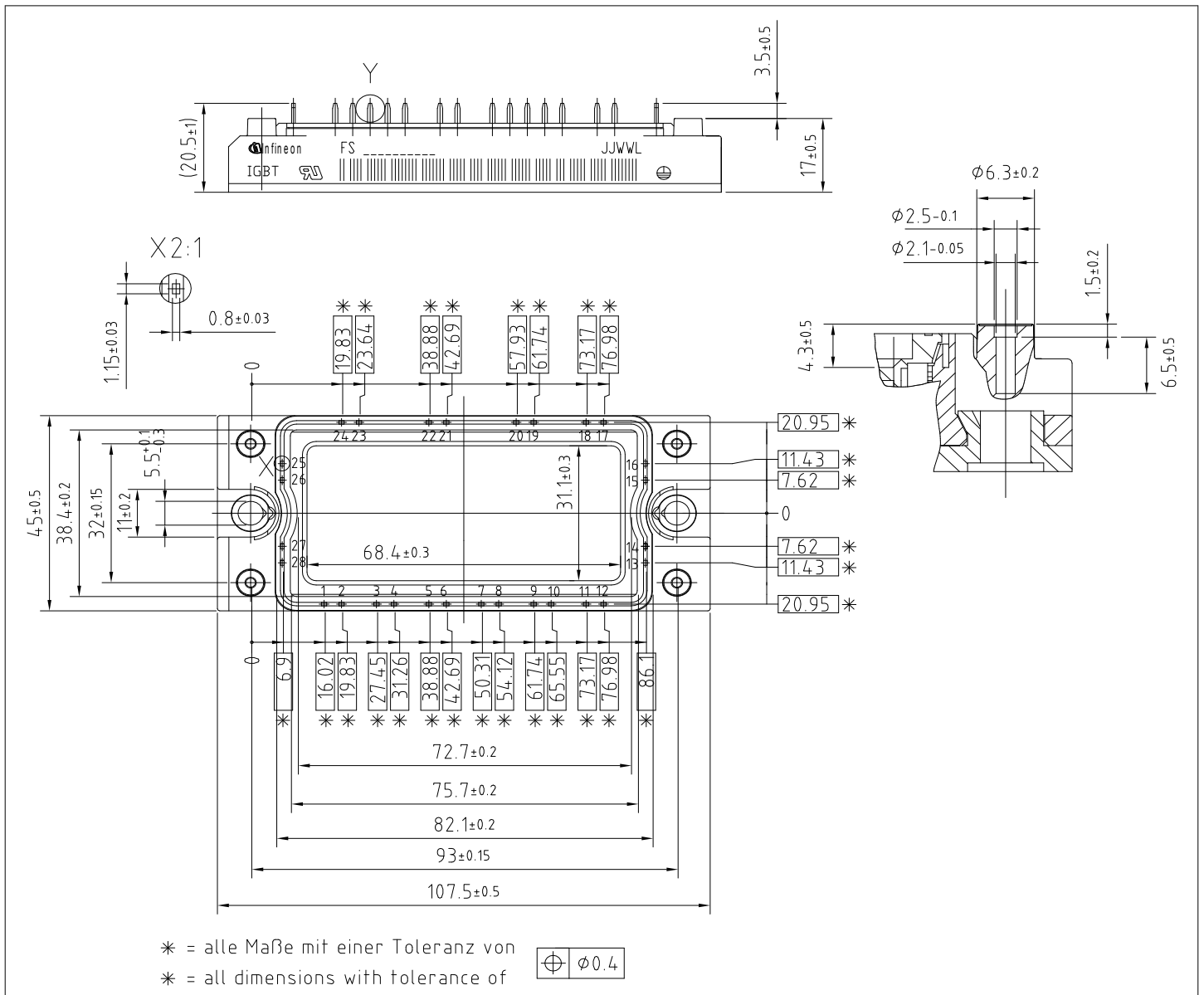

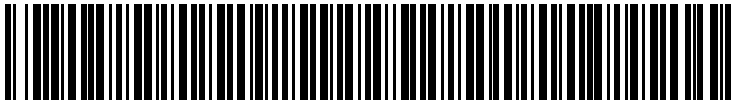


Figure 1

7 Package outlines



## 8 Module label code

Module label code			
Code format	Data Matrix	Barcode Code128	
Encoding	ASCII text	Code Set A	
Symbol size	16x16	23 digits	
Standard	IEC24720 and IEC16022	IEC8859-1	
Code content	<i>Content</i>	<i>Digit</i>	<i>Example</i>
	Module serial number	1 - 5	71549
	Module material number	6 - 11	142846
	Production order number	12 - 19	55054991
	Date code (production year)	20 - 21	15
	Date code (production week)	22 - 23	30
Example	 		
	71549142846550549911530		71549142846550549911530

**Figure 3**

## Revision history

Document revision	Date of release	Description of changes
1.00	2021-12-16	Final datasheet

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**Document reference**

**IFX-ABA335-001**

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